

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIII)

## **TPC6003**

# Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance:  $RDS(ON) = 19 \text{ m}\Omega(typ.)$
- High forward transfer admittance:  $|Y_{fs}| = 7 S$  (typ.)
- Low leakage current:  $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement-model:  $V_{th}$  = 1.3 to 2.5 V ( $V_{DS}$  = 10 V,  $I_{D}$  = 1 mA)

#### **Maximum Ratings (Ta = 25°C)**

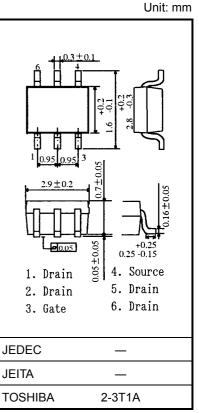
Characteristics		Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	30	V	
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	30	V	
Gate-source voltage		$V_{GSS}$	±20	V	
	DC	1-	6		
Drain current	(Note 1)	Ι <sub>D</sub>	0	А	
Drain current	Pulse	l==	24	^	
	(Note 1)	I <sub>DP</sub>	24		
Drain power dissipation	(t = 5 s)	D-	2.2	W	
	(Note 2a)	$P_{D}$	2.2		
Drain power dissipation	(t = 5 s)	PD	0.7	W	
	(Note 2b)	۲۵	0.7	VV	
Single pulse avalanche energy (Note 3)		E <sub>AS</sub>	5.8	mJ	
Avalanche current	I <sub>AR</sub>	3	Α		
Repetitive avalanche energy (Note 4)		E <sub>AR</sub>	0.22	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t=5\;s) \eqno(Note\;2a)$	R <sub>th (ch-a)</sub>	56.8	°C/W
Thermal resistance, channel to ambient $(t=5\;s) \eqno(Note\;2b)$	R <sub>th (ch-a)</sub>	178.5	°C/W

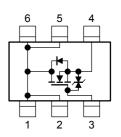
Note: (Note 1), (Note 2), (Note 3), (Note 4), (Note 5) Please see next page.

This transistor is an electrostatically sensitive device. Please handle it with caution.

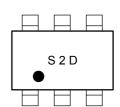


Weight: 0.011 g (typ.)

#### **Circuit Configuration**



#### Marking (Note 5)





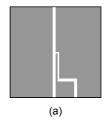
### Electrical Characteristics (Ta = 25°C)

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ	
Drain cut-OFF cu	rrent	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	10	μΑ	
Drain-source breakdown voltage		V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	30	_	_	V	
		V <sub>(BR) DSX</sub>	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	_	_	V	
Gate threshold vo	oltage	V <sub>th</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	1.3	_	2.5	V	
Drain-source ON resistance		_	$V_{GS} = 4.5 \text{ V}, I_D = 3 \text{ A}$	_	25	32	- mΩ	
		R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A	_	19	24		
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3 A	3.5	7	_	S	
Input capacitance Reverse transfer capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1250	_	pF	
		C <sub>rss</sub>		_	155	_		
Output capacitance		C <sub>oss</sub>		_	170	_		
Switching time	Rise time	t <sub>r</sub>	V <sub>GS</sub> 10 V   I <sub>D</sub> = 3 A   C <sub>C</sub>   C <sub>C</sub>	_	5	_	- ns	
	Turn-ON time	t <sub>on</sub>		_	11	_		
	Fall time	t <sub>f</sub>		_	9	_		
	Turn-OFF time	t <sub>off</sub>	$V_{DD} \simeq 15 \text{ V}$ Duty $\leq$ 1%, $t_W = 10 \mu\text{s}$	_	63	_		
Total gate charge (gate-source plus gate-drain)		Qg		_	25	_	nC	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	_	20	_		
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	5	_		

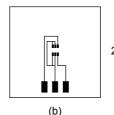
#### Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Pulse drain reverse current	(Note 1)	I <sub>DRP</sub>	_	_	_	24	Α
Forward voltage (Diode)		$V_{DSF}$	I <sub>DR</sub> = 6 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

- Note 1: Please use devices on condition that the channel temperature is below 150°C.
- Note 2: (a) Device mounted on a glass-epoxy board (a)
- (b) Device mounted on a glass-epoxy board (b)

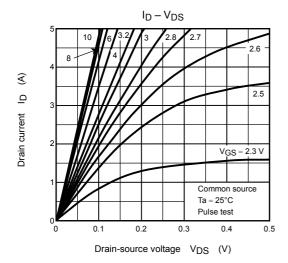


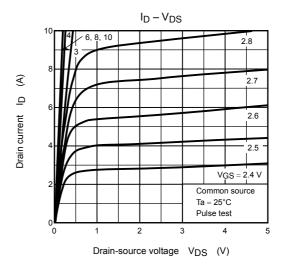
FR-4 2510 ms\*

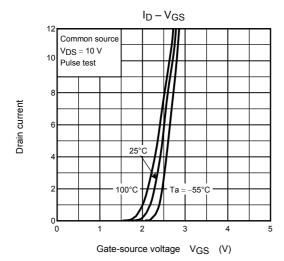


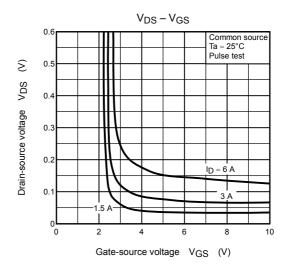
FR-4  $25.4 \times 25.4 \times 0.8$  Unit: (mm)

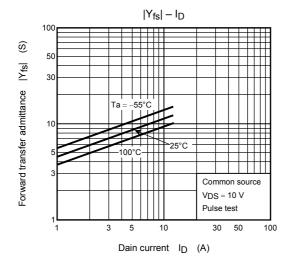
- Note 3:  $V_{DD}$  = 24 V,  $T_{ch}$  = 25°C (initial), L = 0.5 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 3.0 A
- Note 4: Repetitive rating; pulse width limited by maximum channel temperature
- Note 5: Black round marking "●" locates on the left lower side of parts number marking "S2D" indicates terminal No.1.

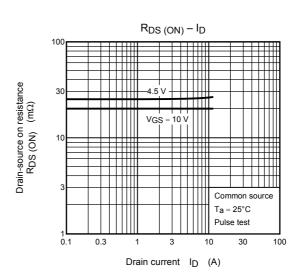




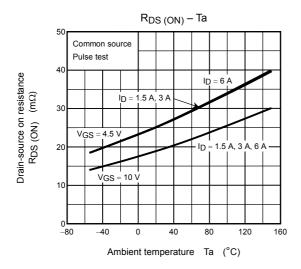


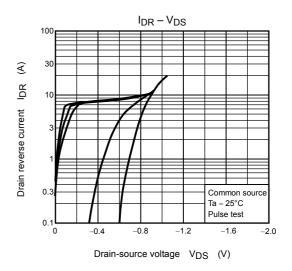


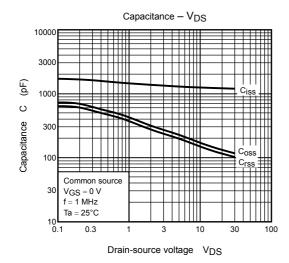


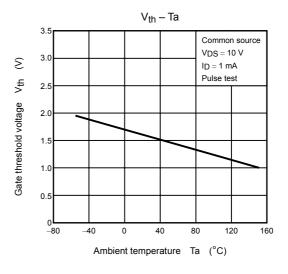


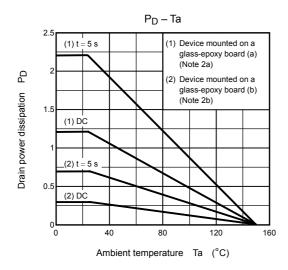
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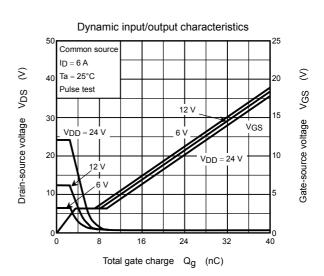


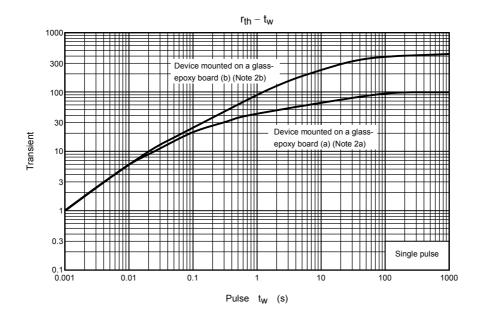


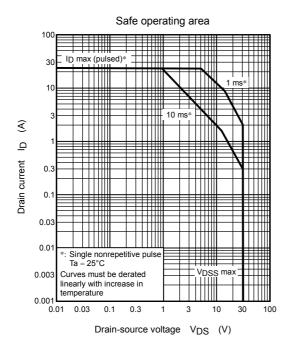












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